Product Qualification Report

ICB1FL02G

Fluorescent Ballast IC

Description

This product qualification report describes the characteristics of the product with respect to quality and reliability.

The qualification sample selection was done on production lots which were manufactured and tested on standard production processes and meet the defined requirements.

The qualification test results of those products as outlined in this document are based on **JEDEC** for target applications and may reference existing qualification results of similar products. Such referencing is justified by the structural similarity of the products.

Qualification Assessment

Qualified according to **JEDEC Standard** and assessed as PASS

For further information about comparable products, please contact the nearest Infineon Technologies office (www.infineon.com).

ICB1FL02G **qualified in 2008**
PG-DSO-18
MSL: 3; 260°C

Electrical Stress Test Results:

Test Description	Abbr.	Condition	Duration	Lots/SS	Fail/Qty	Result
High Temperature Operating Life JESD22 A108	HTOL	Ta = 125°C	1000 h	3x25	0/75	PASS
Temperature Humidity Test (biased) JESD22 A101	THB*	Ta = 85 °C RH = 85 %	1000 h	3x25	0/75	PASS
ESD Human Body Model JESD22 A114	ESD HBM	Class 2 2000 V to < 4000 V	-	-	-	PASS
ESD Charged Device Model JESD22 C101	ESD CDM	Class C2 500 V to < 1000 V	-	-	-	PASS
Latch-Up JESD78	LU	-	-	-	-	PASS

Environmental Stress Test Results:

Test Description	Abbr.	Condition	Duration	Lots/SS	Fail/Qty	Result
Pre-Conditioning J-STD-20/JESD22 A113	PC	MSL and 3 x reflow	-	9x25	0/225	PASS
Temperature Cycling JESD22 A104	TC*	-65°C to +150°C	500 cyc	3x25	0/75	PASS
Unbiased Highly Accelerated Stress Test JESD22 A102	AC*	Ta = 121°C RH = 100 %	96 h	3x25	0/75	PASS
High Temperature Storage Life JESD22 A103	HTSL	Ta = 150°C	1000 h	3x25	0/75	PASS

Notes:
* For SMD devices reliability stress tests performed after pre-conditioning test (PC)

Further abbreviations: MSL - moisture sensitivity level, Qty – quantity, RH – relative humidity, SS – sample size, Ta – ambient temperature

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Document reference

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